Image Sensors



- IMS512
- ■IMP2F (power supply unit)
- ■IML Series (light source)

IMS512_{series}



High-accuracy, high-resolution, compact and low-cost

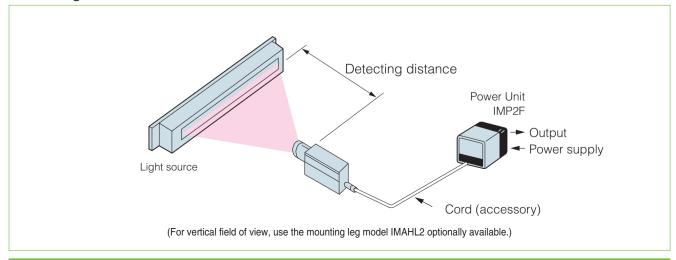
- Video signal scanning cycle of 0.33 ms (min.) allowing detection of objects moving at high speed. Cycle variable between 0.33 and 2.2 ms with digital switch.
- Light axis monitor with LED indicator facilitating light axis and light intensity adjustment
- Field of view adjustment (variable field of view) simply monitored with video output
- Auto slicing feature following variation of received light intensity eliminating fine-tuning at slice level, allowing stable detection unaffected by intensity variation of light source due to temperature variation

Type

Туре	Model	Detection field of view	Detecting distance
Image Sensor	IMS512	1-bit side (Top view) 512-bit side	300mm-



Configuration



IMS

■ Rating/Performance/Specification

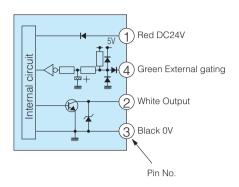
	Model	IMS512				
	Bit count	512bit				
	Detecting distance	300mm-				
Rating/performance	Orientation of field of view	1-bit side (Top view)				
form	Resolution / Detecting distance	0.25mm max / 300mm				
/per	Effective detecting width / Detecting distance	110mm max / 300mm				
ting	Scanning cycle	About 0.33-2.2ms (128 us/step 15steps variable)				
Ra	Coting input	Detection permitted: H (4-24 V) or open				
	Gating input	Detection inhibited: L (0-1 V) Response time: 10 ms (max.)				
	0.1.1	NPN open collector output				
	Output	Rating: 30V DC 100mA max. Short circuit protection circuit provided				
	Power supply	24V DC ±10% / Ripple 10% max.				
	Current consumption	230mA max.				
	Matching	 DARK-LIGHTOutput if field of view contains dark (DARK) or bright LIGHT) area LARGE-SMALLOutput when bit count for detection area is larger (LARGE) or smaller (SMALL) than the reference TOTAL-SINGLEFor differentiation between large and small, specify TOTAL for overall matching of detection areas and SINGLE for matching of individual area 				
ر	Indicator	 Light intensity level "insufficient" indicator Light intensity level "(1-bit side)" indicator Light intensity level "(512-bit side)" indicator OP.L: Operation indicator 				
Specification	Switch (SW)	 Set switches (sliding switches) FAST-SLOW: switches between speeds at which the slice level follows variation of received light intensity for auto slicing DARK-LIGHT: switches between modes for detection (DARK: detection of dark area; LIGHT: detection of bright area) OFF-ON: enables/disables preset matching (OFF: normal detection; ON: preset matching LARGE-SMALL: switches between modes for preset matching (LARGE: detection of larger count; SMALL: detection of smaller count) TOTAL-SINGLE: switches between modes for preset matching (TOTAL: overall matching; SINGLE: individual matching) Sensing time adjustment: adjusts the scanning cycle between about 0.33 and 2.2 ms. Preset switch: specifies the reference value for preset matching Digits (from left): hundreds digit, tens digit, units digit in decimal system VIEW switch: 2 for 1-bit and 512-bit sides 				
	Wiring	Connector type / Cord: 0.3 mm² x 4 cores, 2m				
	Case material	Aluminum				
	Mass	500g max.				

Environmental Specification

	Ambient temperature	0 - +55 °C (non-freezing)	
ij	Storage temperature	-20 - +70 °C (non-freezing, non-condensing)	
Environment	Ambient humidity	35-85%RH (non-condensing)	
viro	Protective structure	IP40	
핍	Vibration	10-55 Hz / 1.5 mm amplitude / 2 hours each in 3 directions	
	Shock	300 m/s² / 2 times each in 3 directions	

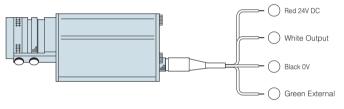
IMS

Input/Output Circuit and Connection

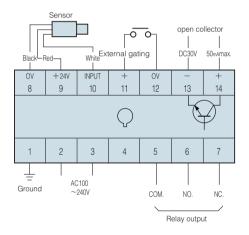


The output transistor turns off when load short circuit or overload occurs. *Leave the external gating terminal open if unused.

Connection



(Special power supply unit: in combination with IMP2F)



ピン配列 (2) 4)

Resolution and Measurement Accuracy

Resolution can be calculated by dividing the entire field of view (at 0.0) by 512.

The following formula provides an approximate resolution.

X = Distance (mm)

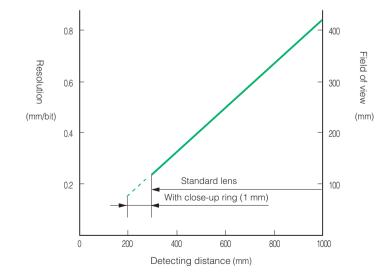
Y = Resolution (mm)

Y = (0.44X - 15)/512

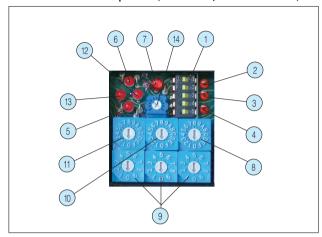
X = (512Y + 15)/0.44

Measurement accuracy can be described as follows:

*Measurement Accuracy ≥ Resolution x 2



Panel Description (with rear panel removed)



(1)Set switches

switches between speeds at which · FAST-SLOW:

the slice level follows variation of received light intensity for auto slicing. Normally set this switch at FAST.

<FAST: fast speed; SLOW: slow speed> switches between modes for detection.

· DARK-LIGHT: <DARK: detection of dark area, LIGHT: detection of bright area)</p>

enables/disables preset matching. · OFF-ON:

Preset matching is a function that compares the detected bit count and value preset with digital switch for matching.

· LARGE-SMALL: <OFF: normal detection; ON: preset matching>

switches between modes for detection.

LARGE specifies activation when detected bit count is

equal to or larger than the preset value. SMALL specifies activation when bit count is equal to or smaller than the preset value. <LARGE: detection of larger count; SMALL:

detection of smaller count>

· TOTAL-SINGLE: switches between modes for detection.

TOTAL specifies matching with the total bit count, or cumulative total of count for all detection areas. SINGLE specifies matching with the bit count for each

detection area in the same field of view.

<TOTAL: overall matching; SINGLE: individual matching>

2 Video monitor pin

Pin that outputs video signal, which can be used for adjustment while monitoring with an oscilloscope.

3 Sensing monitor pin

Pin that outputs sensing signal, which can be used as timing for oscilloscope during video signal monitoring.

4 Ground pin

Pin for 0 V, which can be used as the ground of the probe for monitoring.

⑤Light intensity level (insufficient)

Illuminated when the received light intensity is not sufficient.

6 Light intensity level (saturated)

Illuminated when the received light intensity is saturated.

70P.L

Illuminated when the output is activated.

8 Sensing time adjustment switch

Adjusts the scanning cycle between about 0.33 and 2.2 ms. Larger value increases the cycle and light intensity. The sensing time can be calculated with the following formula:

Ts: Sensing Time (ms) X: Setting (on switch)

Ts (ms) $\approx 0.33 + 0.128x$

(Ex.) With setting 8

 $Ts \approx 0.33 + 0.128 \times 8 \approx 1.4 \text{ (ms)}$

With setting F (= 15) Ts \approx 0.33 + 0.128 x 15 \approx 2.2 (ms)

9 Preset switch

Specifies the reference value for preset matching. Digits (from left): hundreds digit, tens digit, units digit in decimal system

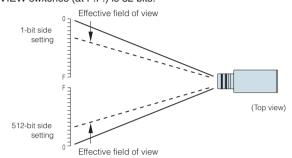
(Ex.) Preset value 248

10 VIEW (field of view) switch [1-bit side]

Use this switch when the field of view contains the same conditions as the LIGHT and DARK settings that needed to be excluded from the detection. Also adjust this for decreasing the received light intensity for setting only at the center of the field of view. Setting "0" specifies the maximum field of view and increasing the setting by 1 narrows the field by 16 bits from the 1-bit side.

①VIEW (field of view) switch [512-bit side]

Narrows the field of view from the 512-bit side. The minimum field of view available with the 1-bit and 512-bit VIEW switches (at F.F.) is 32 bits.



DLight axis level [1-bit side]

Illuminated when partial light intensity degradation caused by light axis misalignment or light blocking object is present for the received light intensity level between the center of the field and 1-bit side.

¹³Light axis level [512-bit side]

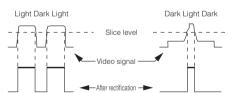
Illuminated when partial light intensity rise is present for the received light intensity level between the center of the field and 1-bit side.

(!) Auto slicing adjustment

Adjusts the level for auto slicing. Turning clockwise increases the level and counterclockwise decreases the level. Generally, set at the center. *For initial light axis alignment, turn clockwise all the way.

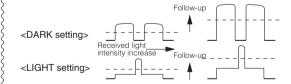
Auto slicing and adjustment

Slicing is to rectify signals by binarizing analog level difference between dark and light of video signals at the reference (slice) level.



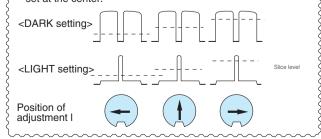
2 Auto slicing

Auto slicing automatically adjusts the slice level based on the received light intensity and the DARK-LIGHT setting.



3Slice adjustment

Allows increase or decrease of the auto slice level. Generally set at the center

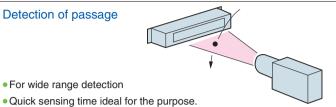


IMS

Sample Applications and Settings

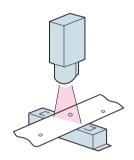
Detection of passage

For wide range detection



FAST		SLOW
DARK	•	LIGHT
OFF		ON
LARGE		SMALL
TOTAL		SINGLE

Pinhole detection

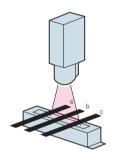


FAST	•	SLOW
DARK		LIGHT
OFF		ON
LARGE		SMALL
TOTAL		SINGLE

Pay attention to the relation between the line speed and the object diameter.

SMALL-TOTAL matching

• When three objects a, b and c are being fed and the width is the same for the three at 50 bits, detection signal is output when any of the three is missing.



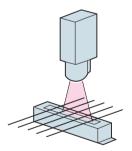
FAST		SLOW
DARK	•	LIGHT
OFF		ON
LARGE		SMALL
TOTAL		SINGLE

• Preset values:

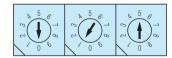
3 detected: 50 (bits) x 3 = 150 (bits) 1 missing: 50 (bits) x 2 = 100 (bits) Setting: (150 + 100)/2 = 125

SMALL-SINGLE matching

- When five objects are being fed and the width is the same for the five at 20 bits, detection signal is output when any of the five is thinner.
- Preset value: 15 bits as opposed to 20 bits for non-defective object.

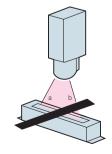


FAST			SLOW
DARK	•		LIGHT
OFF		•	ON
LARGE			SMALL
TOTAL			SINGLE



LARGE-SINGLE matching

- When the object is being fed at the center of the range and the width of the bright areas on both sides a and b is 100 bits, detection signal is output when the object shifts to either side (meanders).
- · Preset value: according to the tolerance for meandering (120 in the example)



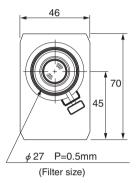
FAST		SLOW
DARK	•	LIGHT
OFF	•	ON
LARGE		SMALL
TOTAL		SINGLE

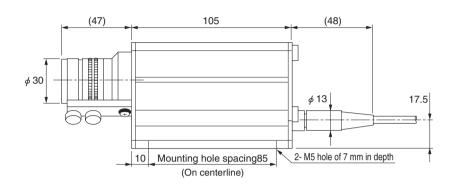


^{*}Set the slicing adjustment slightly low.

Dimensions (mm)

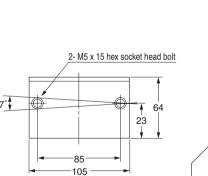
Image sensor IMS512

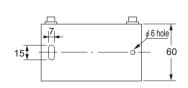




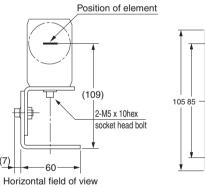
Mounting bracket

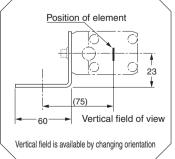
IMAHL2

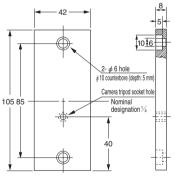




IMAHL3











• High-capacity, compact, plug-in

- IMP2F provides power supply to image sensor of 24 VDC/400 mA max. by connecting 100-220 VAC power.
- Combining with external gating allows logic operations including AND, CLOCK AND and GATE MEMORY.
- Timer function integrated for on-delay, off-delay and one-shot operations by setting switch on the panel in addition to ON-OFF basic operation.

Type

Model	Power supply	Operation mode	Output mode	Timer feature	Power supplied to sensor
IMP2F	100-220V AC	Logic operations AND, CLOCK AND, GATE MEMORY Timer function selectable	Relay contact output NPN open collector	Provided	24V DC 400mA max.

Panel Description

Power indicator

TAKENAKA ELECTRONIC INDUSTRIAL CO., LTD.

Mode switches



IMP2F

Output indicator

OUTPUT



POWER

IMP2F

■ Rating/Performance/Specification

	Мо	del	IMP2F		
	Power	supply	AC100-220V ±10%	50/60Hz	
	Power cor	nsumption	18W max.		
ınce	Operation mode		Logic operation in combination with external gating AND、CLOCK AND、GATE MEMORY	Timer function selectable On-delay, off-delay, one-shot, timer disabled Delay time: 0.1-10 s	
Rating/performance	Output	t mode		250V AC) max. noninductive load A (30V DC), Residual voltage: 1V max.	
d/gc	Power suppl	ied to sensor	DC24V ±10% 400mA (short circuit p	rotection circuit provided)	
Ratir	External gating		Contact input NPN transistor input (L: 1 V max.; H: 8 V min.	.)	
	Response	Input	Sensor input: 50 us max. External gating input: HIGI (GAT.SPEED selector swit	H···50 us max./ LOW30ms max. tch provided)	
	time	Output	Use of timer: Timer duration setting Relay output: 10 m Open collector outp	s max. out: 1 ms max. (with external gate unused)	
	Sensor input		NPN transistor input (L: 1 V max.; H: 8 V min.)		
	Indicator		P.L : power indicator (g	reen LED)	
			OP.L: output indicator (red LED)		
	Volum	Volume (VR) TIME: delay time adjustment (0.1-10 s variable; turn clockwise to increase)			
Specification	Switch	n (SW)	 Logic operation selector switch: See Operation Timer selector switch: OND. (on-delay) OFD. (off-delay) OST. (one-shot) NON TIM. (timer disabled) 	Selectable with switch according to combination table	
S	Case n	naterial	Polycarbonate (g	reen)	
	Conn	ection	Plug-in terminal block (with		
	Ma	ass	320g max.		
Notes Terminal block (TB14) provided		Terminal block (TB14) provided			

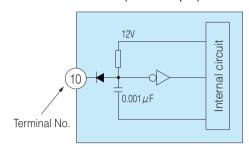
Environmental Specification

	Ambient temperature	-10 - +55 °C (non-freezin	g)			
	Ambient humidity	35-85%RH (non-condensing)				
	Protective structure	IP40				
	Vibration	10-55 Hz / 1.5 mm amplitude / 2 hours ea	ach in 3 directions			
	Shock	1000 m/s² / 2 times each in 3 di	irections			
Environment	Dielectric withstanding /insulation resistance	Between case and power supply Between grounding terminal (FG) and power supply Between case and relay contact Between grounding terminal (FG) and relay contact Between power supply and relay contact Between sensor power supply and power supply Between sensor power supply and grounding terminal (FG) Between open collector output and power supply Between open collector output and grounding terminal (FG) Between open collector output and sensor power supply	$ \left. \begin{array}{c} 2000 \text{V AC for 1 minute} \\ \\ 500 \text{V DC mega} \\ 20 \text{ M}\Omega \text{ or higher} \\ \\ \\ 1000 \text{V AC for 1 minute} \\ \\ 250 \text{V DC mega} \\ \\ 20 \text{ M}\Omega \text{ or higher} \\ \end{array} \right. $			

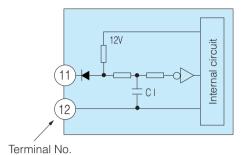
IMP2F

Input Circuit

(Sensor input)



(External gating input) (EXT.GATING)

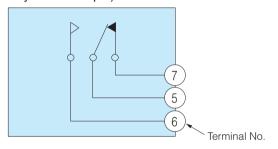


C1: GATE.SPEED HIGH: 0.001 µF LOW: 2.2 µF

Leave open when unused and set the mode switch on the panel $\boxed{\text{EXT.GATING H on L}}$ on at $\boxed{\text{H on}}$.

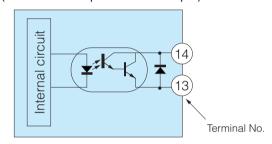
Output Circuit

(Relay contact output)



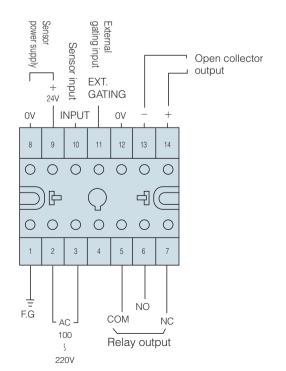
Contact capacity: 250 VAC 3 A (noninductive load)

(Isolation/NPN open collector output)

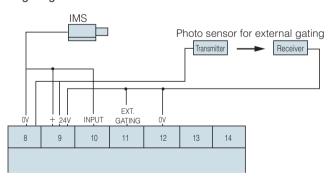


Rating 30V DC / 50 mA max. Residual voltage 1.0 V max.

Connection



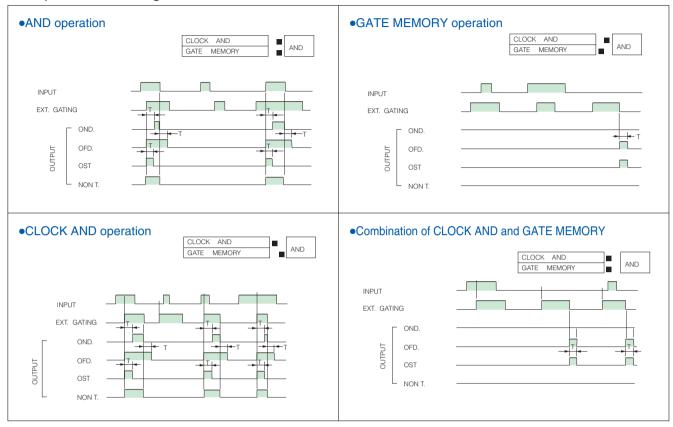
Using image sensor IMS512 and photo sensor for external gating



When image sensor IMS512 is used, the current capacity of the photo sensor for external gating is 50 mA max.

IMP2F

Operation Timing Chart



Operation (description of mode switches)

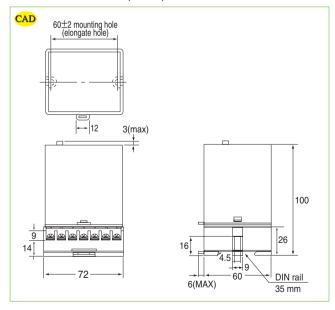
- *INPUT: specifies the operation logic for sensor input.
 - When using image sensor IMS series or activating Light-ON type sensor at light reception, set this switch at Lon.
- *EXT.GATING: specifies the operation logic for external gating.
 - When not using external gating, set this switch at Hon.
- *EXT.GAT.SPEED: selects between the input response times for external gating.
 - For contact input, set this switch at LOW

*CLOCK AND

GATE MEMORY: used in combination with external gating.

- Setting both switches at AND enables ANDing of the sensor and external gating signals for output.
- CLOCK AND enables judgment of the input state of the sensor signal at the moment of input of the gating signal, the result of which is output. One-shot output is normally used for this purpose.
- GATE MEMORY temporarily stores whether sensor input has been supplied during gating signal input for output at the fall of gating signal.
- CLOCK AND and GATE MEMORY may be combined.
- When not using external gating, set the switch at AND

Dimensions (in mm)









• LED type:

·····IML100/IML20D

No fear of burned-out bulbs, long life

Fluorescent lamp

·····Effective light source length: 200~1000 mm

Halogen lamp

.....Suitable for reflective applications

Type

Model	Detection method	Light source	Effective light source length	Light source service life	Power supply
IML10D		LED	100mm	30,000 hours av.	24V DC
IML20D		LLD	200mm		
IML10F	Through- beam type	Fluorescent lamp (high- frequency	200mm	50,000 hours av.	100-110V AC / 200-220V
IML20F			400mm		
IML40F		illumination)	1,000mm		50/60Hz
IML50H	Reflective type	Halogen lamp	35 x 120 mm (at 300 mm)	20,000 hours av.	12V AC/DC

^{*}Power unit IMP50H is separately required.

Optional parts

Type	Model	Description
Power Unit	IMP50H	Power supply for IML50H

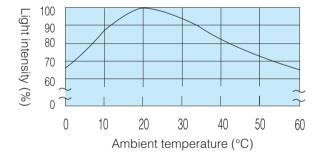


■ Rating/Performance/Specification

	Model	IML10D	IML20D	IML10F	IML20F	IML40F	IML50H	
Rating/performance	Applicable detection method		Reflective type					
	Light source	LE	D	Fluorescent lamp (hi	Halogen lamp 50W			
	Effective light source length	100mm	200mm	200mm	400mm	1,000mm	30 x 120mm (at 300 mm)	
	Power supply	24V DC		100-1	12V AC/DC			
	Current/power consumption	100mA	200mA	20VA	38VA	AV08	5A max.	
R	Light source service life	30,000 hours av.			20,000 hours av.			
	Lamp			FL10D	FL20SD	FLR40SW/MX	12 V 50 W halogen TH-5	
	Ambient temperature		−10 - +55 °C					
	Connection	Permanently att	ached cord type	Connector type			Terminal block	
	Cord	0.3mm ² x 2	2 cores 2m	3C / 2m				
	Mass	130g	260g	3kg	6.8kg	11.1kg	450g (Holder 250g)	
Specification	Notes	illumination When using before using vary dependent of the second of the	When using a fluorescent lamp as the light source, be sure to use high-frequency illumination type dedicated for image sensor. When using a fluorescent lamp as the light source, wait at least 5 minutes after power-up before use. The lamp does not provide sufficient brightness immediately after power-up. vary depending on the ambient temperature, which should be noted for high-accuracy det Note that the window is longer than the effective length and the light intensity may be decrease IML50H may be operated directly with 12 VAC or VDC. Combining it with power sup additionally allows operation with 100/220 VAC.					

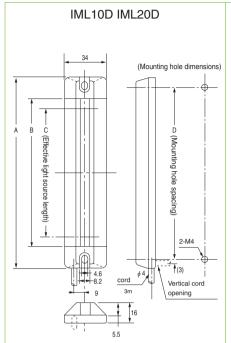
■ Temperature-Light Intensity Characteristics

(Typical example IML10F)

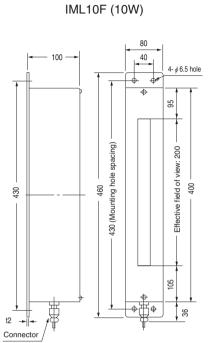


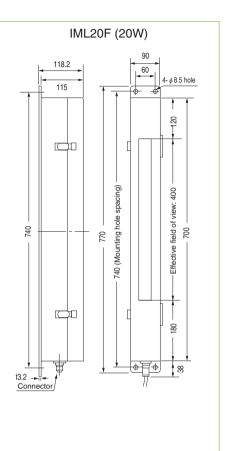
IML

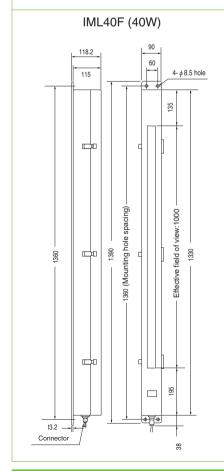
Dimensions (in mm)

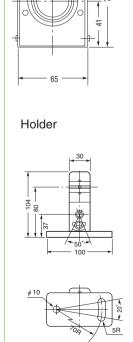


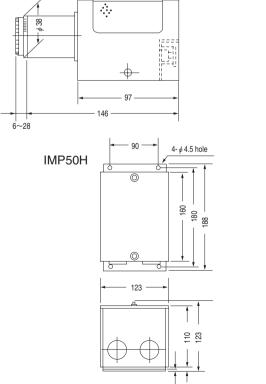
Model	Dimensions of portions (mm)			
Model	Α	В	С	D
IML10D	150	116	100	137
IML20D	250	216	200	237











IML50H